

# SD05T1 Series, SZSD05T1 Series

## ESD Protection Diode

### SOD-323 Diodes for ESD Protection

These surge protection diodes are designed for applications requiring transient overvoltage protection capability. They are intended for use in voltage and ESD sensitive equipment such as computers, printers, business machines, communication systems, medical equipment and other applications. These devices are ideal for situations where board space is at a premium.

#### Specification Features:

- Steady State Power Routing of 300 mW
- Peak Power – 350 W (8 × 20 µs)
- Low Leakage
- Cathode Indicated by Polarity Band
- Package Weight: 4.507 mg/wmt
- Meets IEC61000-4-2 Level 4, 15 kV (Air), 8 kV (Contact)
- Meets IEC6100-4-4 Level 4, 40 A
- Meets IEC6100-4-5 (Lightning), 24 A
- Meets 16 kV Human Body Model ESD Requirements
- SZ Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

#### Mechanical Characteristics:

**CASE:** Void-free, transfer-molded, thermosetting plastic Epoxy Meets UL 94, V-0

**LEAD FINISH:** 100% Matte Sn (Tin)

**MOUNTING POSITION:** Any

**QUALIFIED MAX REFLOW TEMPERATURE:** 260°C

Device Meets MSL 1 Requirements

Use the Device Number to order the 7 inch/3,000 unit reel.

Replace the “T1” with “T3” in the Device Number to order the 13 inch/10,000 unit reel.



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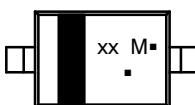
[www.onsemi.com](http://www.onsemi.com)



#### MARKING DIAGRAM



SOD-323  
CASE 477  
STYLE 1



xx = Specific Device Code  
ZA = SD05T1  
ZC = SD12T1  
M = Month Code  
- = Pb-Free Package  
(Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
SD05T1G	SOD-323 (Pb-Free)	3000/Tape & Reel
SZSD05T1G		
SD12T1G		
SZSD12T1G		

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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## MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Peak Power Dissipation @ 20 $\mu$ s (Note 1) @ $T_L \leq 25^\circ\text{C}$	$P_{pk}$	350	Watts
IEC 61000-4-2 (ESD) Air Contact		$\pm 15$ $\pm 8.0$	kV
IEC 61000-4-4 (EFT)		40	A
ESD Voltage (Human Body Model (HBM) Waveform per IEC 61000-4-2)	$V_{PP}$	30	kV
Total Power Dissipation on FR-4 Board (Note 2) @ $T_A = 25^\circ\text{C}$ Derate above $25^\circ\text{C}$	$P_D$	300 2.4	mW mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	416	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$
Lead Solder Temperature – Maximum (10 Second Duration)	$T_L$	260	$^\circ\text{C}$

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

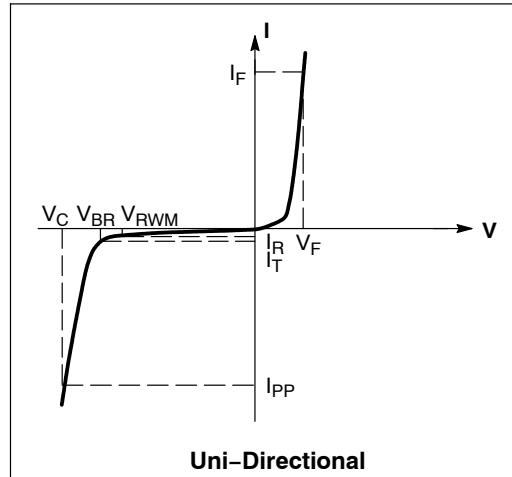
\*Other voltages may be available upon request.

1. Nonrepetitive current pulse, per Figure 6.
2. FR-4 printed circuit board, single-sided copper, mounting pad 1  $\text{cm}^2$ .

## ELECTRICAL CHARACTERISTICS

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

Symbol	Parameter
$I_{PP}$	Maximum Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$
$V_{RWM}$	Working Peak Reverse Voltage
$I_R$	Maximum Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Breakdown Voltage @ $I_T$
$I_T$	Test Current
$I_F$	Forward Current
$V_F$	Forward Voltage @ $I_F$



## ELECTRICAL CHARACTERISTICS

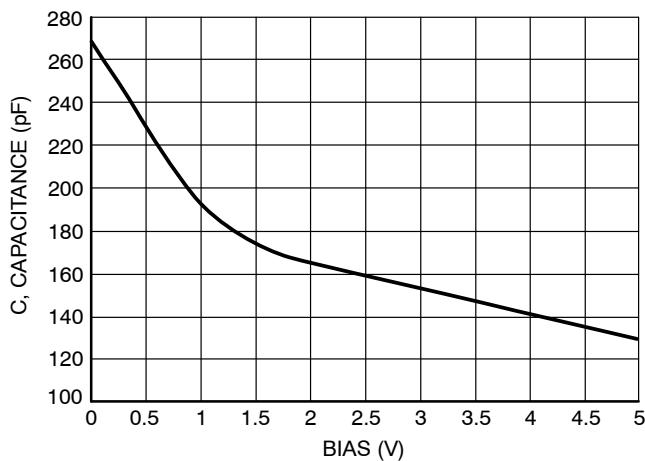
Device	$V_{RWM}$ (V)	$I_R$ @ $V_{RWM}$ ( $\mu\text{A}$ )	$V_{BR}$ , Breakdown Voltage (V)		$I_T$ mA	$V_C$ @ $I_{PP} = 5$ A (Note 3) (V)	Max $I_{PP}$ (Note 3) (A)	$V_C$ @ Max $I_{PP}$ (Note 3) (V)	Max Capacitance (pF)
			Min	Max					
SD05T1G	5.0	10	6.2	7.3	1.0	9.8	24	14.5	350
SD12T1G	12	1.0	13.3	15.75	1.0	19	15	25	150

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

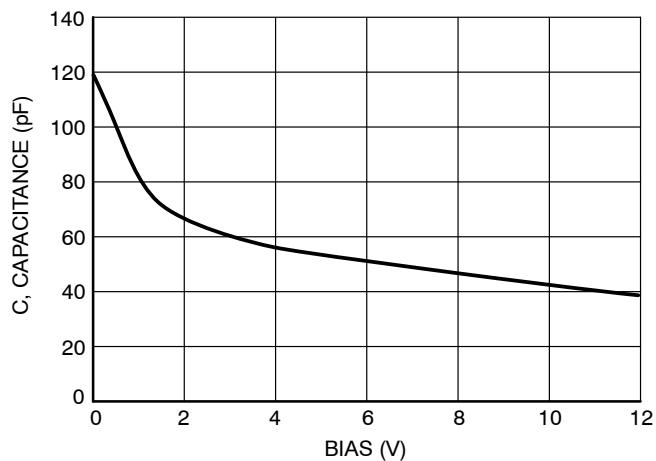
3.  $8 \times 20 \mu\text{s}$  pulse waveform.

\*Include SZ-prefix devices where applicable.

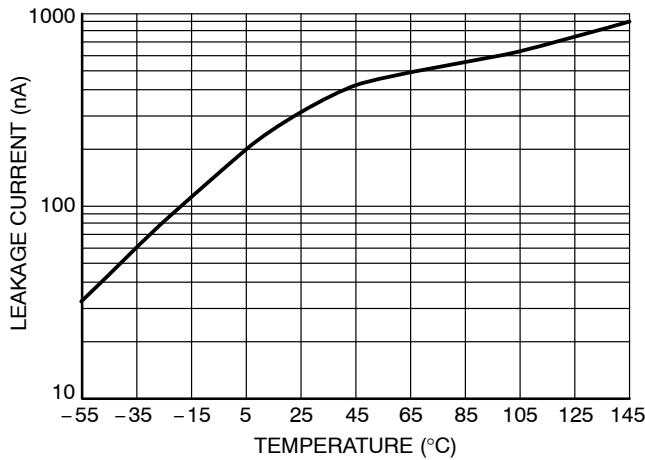
**TYPICAL CHARACTERISTICS**



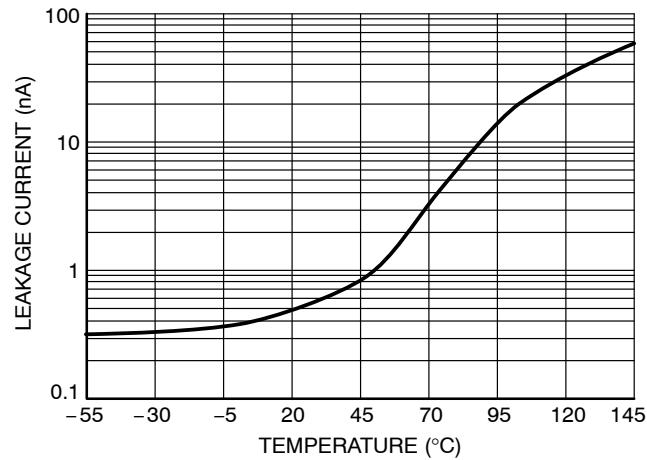
**Figure 1. SD05 Typical Capacitance versus Bias Voltage**



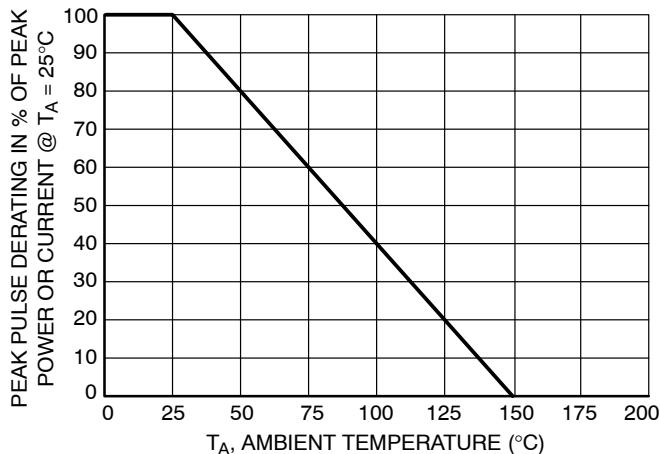
**Figure 2. SD12 Typical Capacitance versus Bias Voltage**



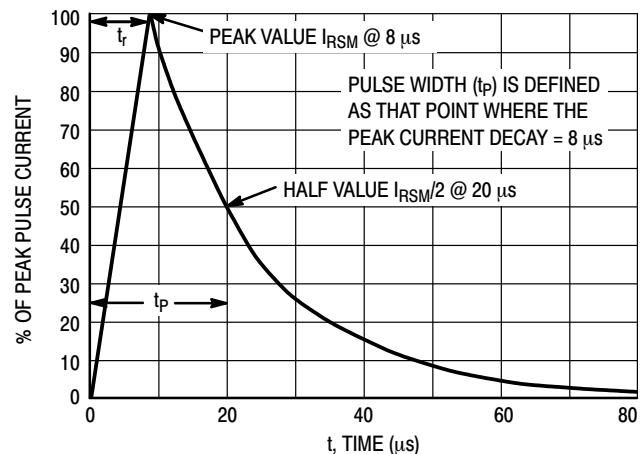
**Figure 3. SD05 Typical Leakage Current versus Temperature**



**Figure 4. SD12 Typical Leakage Current versus Temperature**



**Figure 5. Pulse Derating Curve**

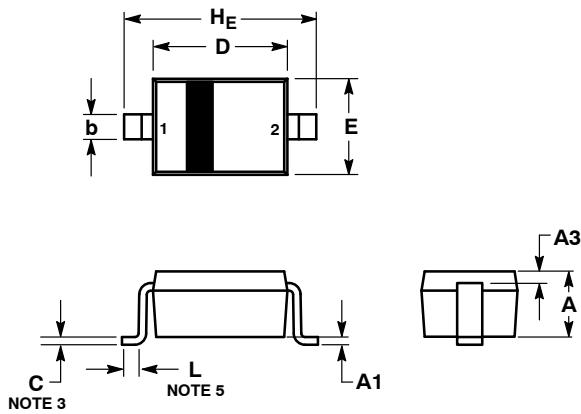


**Figure 6. 8 x 20 μs Pulse Waveform**

# SD05T1 Series, SZSD05T1 Series

## PACKAGE DIMENSIONS

### SOD-323 CASE 477-02 ISSUE H



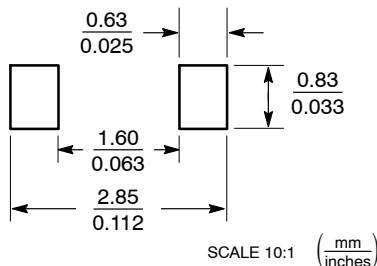
#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. LEAD THICKNESS SPECIFIED PER L/F DRAWING WITH SOLDER PLATING.
4. DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.
5. DIMENSION L IS MEASURED FROM END OF RADIUS.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.90	1.00	0.031	0.035	0.040
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.15	REF		0.006	REF	
b	0.25	0.32	0.4	0.010	0.012	0.016
C	0.089	0.12	0.177	0.003	0.005	0.007
D	1.60	1.70	1.80	0.062	0.066	0.070
E	1.15	1.25	1.35	0.045	0.049	0.053
L	0.08			0.003		
H <sub>E</sub>	2.30	2.50	2.70	0.090	0.098	0.105

STYLE 1:  
PIN 1. CATHODE  
2. ANODE

### SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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